

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

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|---|---|---------------|-------------|--|-------------|
| Title of Invention | METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING IMPROVED HOT CARRIER IMMUNITY ABILITY | | | | |
| Application Number : Date : First Named Applicant: Wen-Koi Lai Confirmation Number: Attorney Docket Number: NAUP0577USA | | | | | |
| <p>I hereby certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.</p> <p>I , the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.</p> | | | | | |
| <table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td></tr><tr><td>Winston Hsu Registered Number: 41,526</td><td>Winston Hsu</td></tr></table> | | Submitted By: | Elec. Sign. | Winston Hsu Registered Number: 41,526 | Winston Hsu |
| Submitted By: | Elec. Sign. | | | | |
| Winston Hsu Registered Number: 41,526 | Winston Hsu | | | | |

| Documents being submitted: | Files |
|----------------------------|---|
| us-declaration | NAUP0577_0_A1-usdecl.xml us-declaration.dtd us-declaration.xsl |
| us-fee-sheet | NAUP0577_0_A1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd |
| us-power-of-attorney-grant | NAUP0577_0_A1-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl |
| us-assignment | NAUP0577_0_A1-usassn.xml us-assignment.xsl us-assignment.dtd NAUP0577_0_A1ASS1.tif NAUP0577_0_A1ASS2.tif NAUP0577_0_A1ASS3.tif |
| us-request | NAUP0577_0_A1-usrequ.xml us-request.dtd us-request.xsl |
| application-body | NAUP0577-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd Naup0577usa-01.tif Naup0577usa-02.tif Naup0577usa-03.tif |

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| | Naup0577usa-10.tif |
| | Naup0577usa-11.tif |
| us-declaration | NAUP0577_0_A1DEC1.tif |
| us-declaration | NAUP0577_0_A1DEC2.tif |
| us-declaration | NAUP0577_0_A1DEC3.tif |
| Comments | |